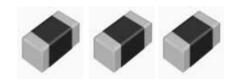
巻線チップインダクタ WOUND CHIP INDUCTORS **CB SERIES**

OPERATING TEMP. -25~+85°C





特長 FEATURES

- ・超小型、大電流の巻線チップインダクタ
- ・実装性、特性において方向性のない形状・DC/DCコンバーター回路向け

- · Small size wound chip inductor with high current.
- · Demension without directional influence on mounterbility and characteristics.
- · For DC-DC converter circuit.

用途 APPLICATIONS

・DVC, MD, PDA等の携帯AV機器, ディジタル機器

· DVC, MD, PDA and other portable digital equipment.

形名表記法 ORDERING CODE



形式 CB 巻線チップインダクタ

> 低 Rdc 大電流 低背

外径寸法 (mm)							
2012(0805)	2.0×1.25						
2016(0806)	2.0×1.6						
2518(1007)	2.5×1.8						
3225(1210)	3.2×2.5						

公称インダクタンス [μH]								
例								
1R0	1							
100	10							
101	100							
※R= 小数点								



個別仕	:様
Δ	標準品
R	低RDC品

当社管理記号						
当社管理記述	7					
$\triangle \triangle \triangle$	標準品					

△= スペース

 $C_1B_1 riangleq 2_10_11_6_T_1_1_0_0_M_1$



Туре Wound chip inductor

External Dimensions (mm) 2012(0805) 2.0×1.25 2016(0806) 2.0×1.6 2518(1007) 2.5×1.8 3225(1210) 3.2×2.5

Nominal Inductance(µH)							
example							
1R0	1						
100	10						
101	100						
	*R=decimal point						

Shape	
Δ	Low Rdc
С	High current Type
L	Low profile

Packaging	
Т	Tape & Reel

Inductance Tolerances (%) M

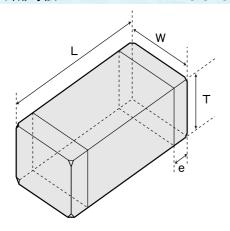
Special code Standard products Low Rdc type



Internal code △△△ Standard Products

__ △=Blank space

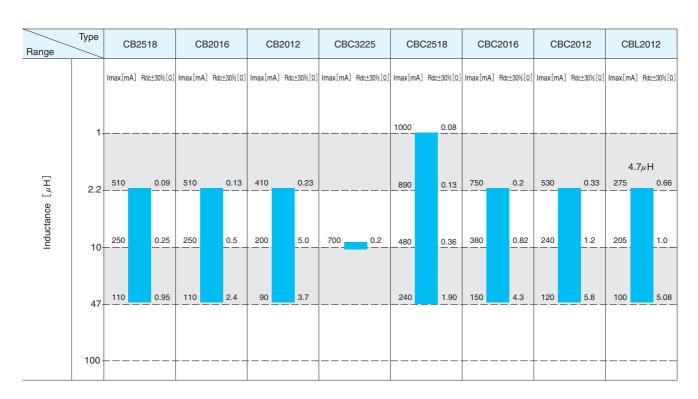
外形寸法 EXTERNAL DIMENSIONS



Туре	L	W	Т	E
000005	3.2±0.3	2.5±0.3	2.5±0.3	0.6±0.3
CBC3225	(0.126±0.012)	(0.098±0.012)	(0.098±0.012)	(0.024±0.012)
CB2518	2.5±0.2	1.8±0.2	1.8±0.2	0.5±0.2
CBC2518	(0.098±0.008)	(0.071±0.008)	(0.071±0.008)	(0.020±0.008)
CB2016	2.0±0.2	1.6 ±0.2	1.6 ±0.2	0.5±0.2
CBC2016	(0.079±0.008)	(0.063±0.008)	(0.063±0.008)	(0.020±0.008)
CB2012	2.0±0.2	1.25±0.2	1.25±0.2	0.5±0.2
CBC2012	(0.079±0.008)	(0.049±0.008)	(0.049±0.008)	(0.020±0.008)
CBL2012	2.0±0.2	1.25±0.2	0.9±0.1	0.5±0.2
OBL2012	(0.079±0.008)	(0.049±0.008)	(0.035±0.004)	(0.020±0.008)

Unit mm(inch)

概略バリエーション AVAILABLE INDUCTANCE RANGE



Irrel	Inductance	Imax [mA]	Rdc±30% [Ω]														
表 催 xamples	1μH	_	_	_	_	_	_	_	_	1000	0.08	_	_	_	_	_	_
×aπ	2.2μH	510	0.09	510	0.13	410	0.23	_	_	890	0.13	750	0.2	530	0.33	275(4.7μH)	0.66(4.7µH)
代司	10 µ H	250	0.25	250	0.5	200	50	700	0.2	480	0.36	380	0.82	240	1.2	205	1.0
	47μH	110	0.95	110	2.4	90	3.7	_	_	240	1.9	150	4.3	120	5.8	100	5.08
	100 μH	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_



etc











CB2012 TYPE -

	形名		公称 インダクタンス	インダクタンス 許容差	自己共振 周 波 数 Self-resonant	直流抵抗 DC Resistance	定格 Rated o	current	測 定 周波数 Measuring
Ordering code	Inductance	Inductance	frequency (MHz)	(Ω)	max.		frequency		
	Ordering code		(μH)	Tolerance	min.	(±30%)	1)	2	(MHz)
СВ	2012T2R2M		2.2		80	0.23	410	770	7.96
СВ	2012T4R7M		4.7		45	0.40	300	580	7.90
СВ	2012T100MR		10	±20%	32	0.5	200	520	
СВ	2012T220M		22		16	1.70	135	280	2.52
СВ	2012T470M		47		11	3.70	90	190	

CB2016 TYPE -

形	名		公称 インダクタンス	インダクタンス 許容差	自己共振 周 波 数 Self-resonant	皮数 DC Resistance		電流 current Aì	測 定 周波数 Measuring
Ordering	code		Inductance [µH]	Inductance Tolerance	frequency (MHz) min.	(Ω) (±30%)	ma ①	•	frequency (MHz)
CB 2016T	Γ2R2M		2.2	10.0.4.100	70	0.13	510	1000	
CB 2016T	Γ4R7M		4.7		45	0.25	340	740	7.96
CB 2016T	Г100М		10	±20%	32	0.5	250	520	
CB 2016T	Γ220M		22		16	1.0	165	370	2.52
CB 2016T	Γ470M	·	47		11	2.4	110	240	

CB2518 TYPE —

形 名	公称 インダクタンス Inductance	インダクタンス 許容差 Inductance	自己共振 周 波 数 Self-resonant frequency [MHz]	直流抵抗 DC Resistance 〔Ω〕	定格電流 Rated current [mA] max.		測 定 周波数 Measuring frequency
	(μH)	Tolerance	min.	(±30%)	(1)	2	(MHz)
CB 2518T2R2M	2.2		68	0.09	510	1300	7.96
CB 2518T4R7M	4.7		46	0.13	340	1100	7.90
CB 2518T100M	10	±20%	30	0.25	250	820	
CB 2518T220M	22		19	0.50	165	580	2.52
CB 2518T470M	47		12	0.95	110	420	

CBC2012 TYPE -

形 名		公称 インダクタンス Inductance	インダクタンス 許容差 Inductance	自己共振 周 波 数 Self-resonant frequency (MHz)	直流抵抗 DC Resistance 〔Ω〕	定格 Rated o 〔m ma	current A)	測定 周波数 Measuring frequency
Ordering code	(μH)	Tolerance	min.	(±30%)	1	2	(MHz)	
CB C2012T2R2M		2.2		70	0.33	530	640	7.96
CB C2012T4R7M		4.7		45	0.50	360	520	7.90
CB C2012T100M		10	±20%	40	1.20	240	340	
CB C2012T220M		22		16	3.70	170	190	2.52
CB C2012T470M		47		11	5.80	120	150	

CBC2016TYPE ----

形名	公称 インダクタンス	インダクタンス 許容差	自己共振 周 波 数 Self-resonant frequency	直流抵抗 DC Resistance	定格電流 Rated current 〔mA〕		測 定 周波数 Measuring
Ordering code	Inductance (µH)	Inductance Tolerance	(MHz) min.	(Ω) (±30%)	ma ①	•	frequency (MHz)
CB C2016T2R2M	2.2		70	0.20	750	720	7.96
CB C2016T4R7M	4.7		45	0.37	550	530	7.96
CB C2016T100M	10	±20%	40	0.82	380	410	
CB C2016T220M	22		16	1.80	250	240	2.52
CB C2016T470M	47		11	4.30	150	150	

[※]一般的な小型パワーチョークコイルの定格電流としては上表の定格電流①を参考にして下さい。

自動復帰回路等を備え、半連続的に5分間以上、大電流が通電する様な回路でご利用される場合には弊社営業に御相談下さい。

定格電流①:公称インダクタンスの-30%を保証する電流値

定格電流②:通電した時に部品温度が ΔT=40℃以内であることを保証する電流値 (インダクタンス値を保証する電流ではありません)

In case of usage in the circuit where large current may be semicontinuously applied over 5 minutes with auto recovery circuit, etc., please contact our sales section before practical application.

Rated current ① : Current value to guarantee -30% of nominal inductance

[※]定格電流②は、DC/DCコンバータの突入電流のような、瞬時であれば通電可能な電流値です。

[%]For rated current of ordinary small power choke coils, please refer to the rated current 1 in the above table.

^{*}Rated current ② is the current for instantaneous flow such as plunging current of DC/DC converter.

Rated current ②: Current value to guarantee component temperature within ΔT =40°C with current flow. (It is not the current to guarantee the inductance value.)

CBC2518 TYPE -

形名	公称 インダクタン	インダクタンス ス 許容差	自己共振 周 波 数 Self-resonant	直流抵抗 DC Resistance	定格電流 Rated current (mA) max.		測 定 周波数 Measuring
Ordering code	Inductance	Inductance	frequency (MHz)	(Ω)			frequency
Ordering code	(μH)	Tolerance	min.	(±30%)	1)	2	(MHz)
CB C2518T1R0M	1.0		100	0.08	1000	1200	
CB C2518T2R2M	2.2		68	0.13	890	1100	7.96
CB C2518T4R7M	4.7	±20%	41	0.20	680	920	
CB C2518T100M	10	120%	30	0.36	480	680	
CB C2518T220M	22		19	0.77	320	460	2.52
CB C2518T470M	47		12	1.90	240	290	

CBC3225 TYPE -

形名		公称 インダクタンス 自己共振 オンダクタンス 許容差 周 波 数 Self-respond				定格 Rated (current	測 定 周波数 Measuring
Ordering code	Inductance	Inductance	frequency (MHz)	Resistance (Ω)	(m ma	_	frequency	
Ordering code		(µH)	Tolerance	min.	(±30%)	1	2	(MHz)
CB C3225T100M		10	±20%	8	0.2	700	760	0.1

CBL2012 TYPE -

形名	公称 インダクタンス	インダクタンス 許容差	自己共振 周 波 数 Self-resonant	直流抵抗 DC Resistance	定格電流 Rated current 〔mA〕		測 定 周波数 Measuring
Ordering code	Inductance	Inductance	frequency (MHz)	(Ω)	ma	•	frequency
Ordering code	(μH)	Tolerance	min.	(±30%)	1)	2	(MHz)
CB L2012T4R7M	4.7		45	0.69	275	490	
CB L2012T100M	10	±20%	32	1.09	205	370	0.1
CB L2012T470M	47		11	5.08	100	140	

- ※一般的な小型パワーチョークコイルの定格電流としては上表の定格電流①を参考にして下さい。
- ※定格電流②は、DC/DCコンバータの突入電流のような、瞬時であれば通電可能な電流値です。

自動復帰回路等を備え、半連続的に5分間以上、大電流が通電する様な回路でご利用される場合には弊社営業に御相談下さい。

定格電流①:公称インダクタンスの-30%を保証する電流値

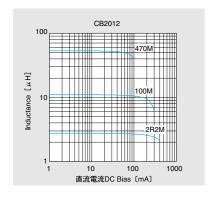
定格電流②:通電した時に部品温度が ΔT=40℃以内であることを保証する電流値(インダクタンス値を保証する電流ではありません)

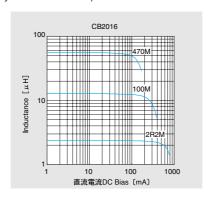
- *For rated current of ordinary small power choke coils, please refer to the rated current ① in the above table.
- \Re Rated current @ is the current for instantaneous flow such as plunging current of DC/DC converter.

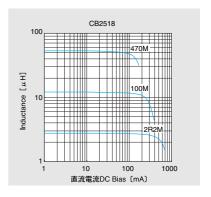
In case of usage in the circuit where large current may be semicontinuously applied over 5 minutes with auto recovery circuit, etc., please contact our sales section before practical application.

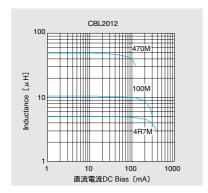
- Rated current $\textcircled{\scriptsize 1}$: Current value to guarantee –30% of nominal inductance
- Rated current ② : Current value to guarantee component temperature within ΔT =40°C with current flow. (It is not the current to guarantee the inductance value.)

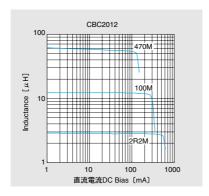
直流重畳特性例 DC Bias characteristics (Measured by HP4285A+42841A)

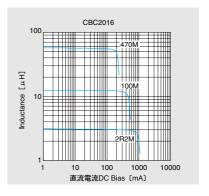


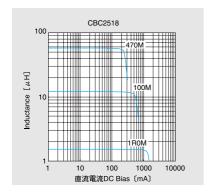


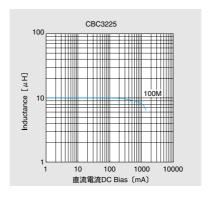






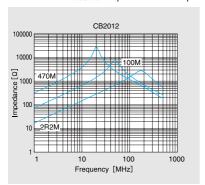


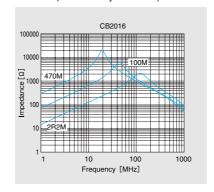


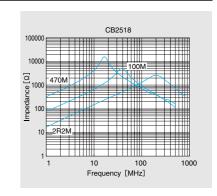


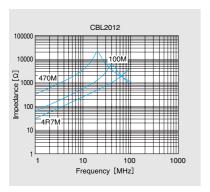
190 TAIYO YUDEN

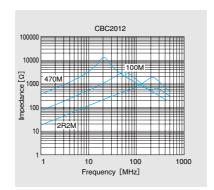
インピーダンス周波数 Impedance-vs-Frequency characteristics (Measured by HP4291A)・

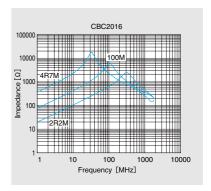


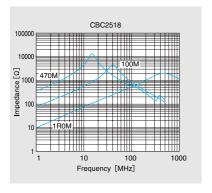


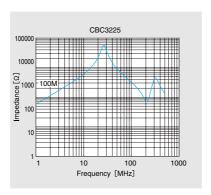










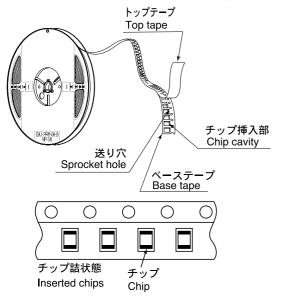


①最小受注単位数 Minimum Quantity

形式	標準数量 Standard Quantity ^[pcs]
Type	テーピング
	Tape&Reel
LB2518 / LBC2518	0000
CB2518 / CBC2518	2000
LB2016 / LBC2016	0000
CB2016 / CBC2016	2000
LB2012 / LBC2012	0000
CB2012 / CBC2012	3000
LBH1608 / LB1608	4000
CBC3225	1000
CBL2012	4000
·	· · · · · · · · · · · · · · · · · · ·

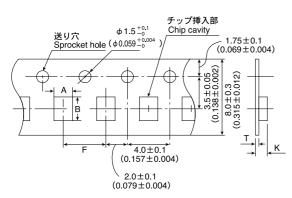
②テーピング材質 Tape material

エンボステープ Embossed tape 紙テープ(LBH1608) Card board carrier tape(LBH1608)



③テーピング寸法 Taping Dimensions

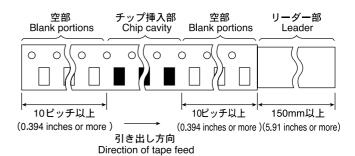
エンボステープ(8mm幅)Embossed Tape (0.315 inches wide) 紙テープ(8mm幅)Paper tape (0.315 inches wide)



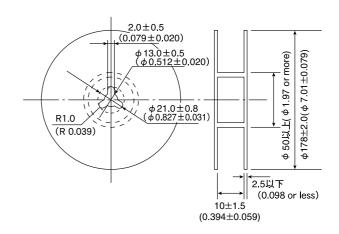
テープ厚み チップ挿入部 挿入ピッチ 形 # Chip Cavity Insertion Pitch Tape Thickness Type В F Α Κ LB2518 / CB2519 2.15±0.1 2.7±0.1 4.0±0.1 0.3 2.1 LBC2518 / CBC2519 (0.085 ± 0.004) (0.107 ± 0.004) (0.157±0.004) (0.083)(0.012)LB2016 / LBC2016 1.9±0.1 2.2 ± 0.1 4.0 ± 0.1 2.15 0.3 CB2016 / CBC2016 (0.157±0.004) (0.085) (0.075 ± 0.004) (0.087 ± 0.004) (0.012)LB2012 / LBC2012 2.3 ± 0.2 0.3 1.5±0.2 4.0 ± 0.1 2.0 CB2012 / CBC2012 (0.059 ± 0.008) (0.091 ± 0.008) (0.157±0.004) (0.079)(0.012)LBH1608 1.0 ± 0.2 1.8 ± 0.2 4.0 ± 0.1 1.1max 1.1max LB1608 (0.059 ± 0.008) (0.091 ± 0.008) (0.157±0.004) (0.079)(0.012) 2.8 ± 0.2 3.5 ± 0.2 4.0 ± 0.2 4.0max 0.6max CBC3225 (0.110±0.008) (0.138 ± 0.008) (0.157±0.003) (0.157)(0.024) 2.3 ± 0.2 4.0±0.1 1.55±0.2 1.1max 1.1max CBL2012 (0.061 ± 0.008) (0.091 ± 0.008) (0.157+0.004) (0.079)(0.079)

Unit: mm (inch)

④リーダ部/空部 Leader and Blank Portion

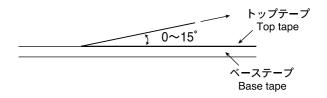


⑤リール寸法 Reel Size



⑥トップテープ強度 Top Tape Strength

トップテープのはがし力は、下図矢印方向にて $0.2\sim0.7$ Nとなります。 The top tape requires a peel-off force of 0.2 to 0.7N in the direction of the arrow as illustrated below.



				Specified Value				
		I DOS 40		Specifica value	000000			
Item	LEM2520	LB2518 LB2016 LB2012 LB1608	LBC2518 LBC2016 LBC2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	LBH1608	Test Methods and Remarks
1.Operating tem- perature Range	-40~+85°C	-25~+85°C						
2.Storage	-40~+85°C	-25~+85°C						
3.Rated Current	Within the specif	lfied tolerance						LEM·LB·LBC Series The maximum DC value having inductance decrease within 10% and temperature increas within 20°C by the application of DC bias. CB·CBC·CBL Series The maximum DC value having inductance decrease within 30% and temperature increas within 40°C by the application of DC bias. LBH1608: The maximum DC value having temperature increas within 20°C by the application of DC
4.Inductance	Within the specif	fied tolerance						bias. YLEM Series 5N6VR10: Measuring equipment: Impedance analyzer (HP4291A or its equivalent) Measuring frequency: Specified frequency LEM Series R12~221: Measuring equipment: LCR Meter (HP4285A+42851A or its equivalent) Measuring frequency: Specified frequency LB·LBC·CB·CBC·CBL Series: Measuring equipment: LCR Mater (HP4285A or its equivalent) LBH1608 Series: Measuring equipment: Impedance analyzer (HP4291A or its equivalent)
5.Q	Within the specified tolerance						12~18 (at 100MHz) min	LEM Series R12~221: Measuring equipment: LCR Meter (HP4285A+42851A or its equivalent) Measuring frequency: Specified frequency LBH1608 Series: Measuring equipment: Impedance analyzer (HP4291A or its equivalent)
6.DC Resisitance	Within the speci	fied tolerance					1	LEM · LB · LBC · CB · CBC · CBL · LBH Series: Measuring equipment: low ohmmeter (A&D AD5812 or its equivalent)

				Specified Value					
Item	LEM2520	LB2518 LB2016 LB2012 LB1608	LBC2518 LBC2016 LBC2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	LBH1608	Te	est Methods and Remarks
7.Self-Resonant	Within the specif	fied tolerance			•			LEM2520):
Frequency								Measurin	g equipment: Network analyzer (Anritsu MS620J or its equivalent)
								LB·LBC	· CB · CBC · CBL Series :
								Measuring	g equipment : Impedance analyzer
									(HP4291A or its equivalent)
								LBH1608	
								Measurin	g equipment : Network analyzer
8.Temperature Char-	△L/L→	△L/L→	T	△L/L→	3225	△L/L→	△L/L→	Change	(HP8720B or its equivalent) of maximum inductance deviation
acteristic	Within±5%	Within±15%	2518	Within±15%	2518	Within±15%	Within±5%	in step 1-	
			2016		2016		* △L/L→		
			△L/L→		△L/L→		Within±0.5nH	*Exclude	e CM03MS series
			Within±20%		Within±20%		under 8.2nH	Step	Temperture (°C)
								1	20
			2012		2012			2	-25
			△L/L→ Within±30%		△L/L→ Within±30%			3 4	20 (Reference temperature) +85 (Maximum operating temperature)
			WILLIIII ±30%		WILLIIII±30%			5	20
9.Rasistance to Flex-	No breakdown o	or damage	ı	I	1		ı	Warp: 2m	nm (LBC, LB, CB, CBC, CBL, LBH Series)
ure of Substrate								: 3m	nm (LEM2520)
									strate: Printed board
								Accoding	to JIS C0051
									Pressig jig
									Thickness LB1608 0.8mm Others 1.0mm
								R5	Board 45±2mm
10.Body Strength	No breakdown o	or damage						1	orde: 15N
								Duration	
									· CB · CBC · CBL · LBH · LEM2520
								Applide for Duration	orde: 10N
								LB1608	· 10360.
								Applide fo	orde: 5N
								Duration	
11.Self Resonant	△L/L→Within-	10%		△L/L→Within—	30%		△L/L→	Measure i	inductance with application of rated
Freguency							Within-10%		sing LCR metre to cpmpare it with
								the initial	value. (* Excluding 5N6~R10)

				Specified Value				
Item	LEM2520	LB2518 LB2016 LB2012 LB1608	LBC2518 LBC2016 LBC2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	LBH1608	Test Methods and Remarks
12.Adhesion of terminal	Shall not come of	off PC board.				1	'	LB·LBC·CB·CBC·CBL·LBH·LEM2520
electrode								Applied force: 10N to X and Y directions
								Duration: 5 sec.
								Test substrate: Printed board
13.Resistance to vibra-	△L/L→	△L/L→Within±10	.0.4				NI simulation at	
tion	∠L/L→ Within±5%						No significant	LEM·LB·LBC·CB·CBC·CBL:
tion		No significant abno	ormality in appearan	ce.			abnormality in	According to JIS C5102 clause 8.2.
	No significant abnormality in						appearance.	Vibration type: A
	appearance.							Directions: 2 hrs each in X, Y and Z direc-
	арреагапсе.							tions. Total: 6 hrs
								Frequency range: 10 to 55 to 10 Hz (1min.)
								Amplitude: 1.5mm Mounting method: Soldering onto printed board
								(* Excluding 5N6-R10 LE
								Series)
								Recovery : At least 1 hr of recovery under
								the standard condition after the
								test, followed by the measure-
								ment within 2 hrs.

				Specified Value				
Item	LEM2520	LB2518 LB2016 LB2012 LB1608	LBC2518 LBC2016 LBC2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	LBH1608	Test Methods and Remarks
14.Drop test	△L/L→							LEM:
	Within±5%							Drop test
	No significant							Impact material: concreta or vinyl tile
	abnormality in							Height: 1m
	appearance.							Total number of drops: 10 times
								LEM2520
								Acceleration: 980m/sec ²
								Duration: 6msec
								Number of times: 6 sides × 3 times
								Mounting method: Soldering onto printed board
								(* Excluding 10N~R10)
								Recovery: At least 1 hr of recovery under
								the standard condition after the
								test, followed by the measure-
								ment within 2 hrs.
15.Solderability	At least 90% of e	electrode						LEM:
								Solder temperature : 230±5℃
								Duration: 5±0.5sec. (LEM2520)
								Fiux: Methanol solution with 25% of
								colophony
								LB·LBC·CB·CBC·CBL·LBH:
								Solder temperature : 230±5℃
								Duration: 5±0.5sec
								Fiux: Methanol solution with 25% of
								colophony

				Specified Value				
Item	LEM2520	LB2518 LB2016 LB2012 LB1608	LBC2518 LBC2016 LBC2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	LBH1608	Test Methods and Remarks
16.Resisitance to	No significant ab	onormality in appea	rance				1	Conduct following wave soldering twice.
soldering heat								300 280
17.Resisitance to	No significant ab	onormality in appear	rance					Solvent temperature: Room temperature
soolvent	No significant au	поппану ії арреа	ance.					Type of solvent : Chlorocarbon type (LEM2520) Isopropyl alcohol (LB·LBC·CB·CBC·CBL) Cleaning conditions : Output : 20mW/cm³ Frequency : 28kHz Duration : 1 min Conduct ultrasonic cleaning. (LEM2520) 90s. Immersion and cleaning. (LB·LBC)

				Specified Value							
Item	LEM2520	LB2518 LB2016 LB2012 LB1608	LBC2518 LBC2016 LBC2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	LBH1608		Test Metho	ods and Rema	ırks
18.Thermal shock	△L/L→	△L/L→Within±10	0%		•	•	△L/L→	Conc	litions for 1cy	cle	
	Within±10%						Within±5%	Step	Temperature(℃)	Duration(min)	
	Q→						%△L/L→	1	-40	30	
	10N: 10min.						within±0.5nH	2	+85	30	
	12N~33N:						under				_
	15min.						8.2 n H	Temp	perature for: L	EM2520	
	39N~R10:						△Q/Q→				
	20min.						within±20%	Num	ber of cycle :	100 cycle	
	R12~4R7:						%△Q/Q→	Reco	very: At leas	t 1 hr of recove	ry the stan-
	30min.						within±5 under		dard co	ondition after t	he removal
	5R6~330:						8.2 n H		from te	st chamber, f	ollowed by
	25min.								measu	rement within	2 hrs.
	390~820:										
	20min.							LB · LBC · CB · CBC · CBL · LBH :			
	101:15min.							-40~	~+85°C, mianta	ain times 30mir	n. ,100 cycle
								Reco	very: At leas	st 1 hr of reco	very under
									the sta	ndard condition	on after the
									test, fo	ollowed by the	measure-
									ment v	vithin 2 hrs.	
19.Damp heat	△L/L→	△L/L→Within±10	%				△L/L→	Temp	perature: 60:	±2°C	
	Within±10%						Within±5%	Humi	idity: 90~95	%RH	
	Q→						%△L/L→	Dura	tion:1000 hi	rs	
	10N: 10min.						within±0.5nH	Reco	very: At leas	1 hr of recove	ry the stan-
	12N~33N:						under		dard co	ondition after t	he removal
	15min.						8.2 n H		from te	st chamber, f	ollowed by
	39N~R10:						△Q/Q→		measu	rement within	2 hrs.
	20min.						Within±20%				
	R12~4R7:						%△Q/Q→				
	30min.						within±5 under				
	5R6~330:						8.2 n H				
	25min.										
	390~820:										
	20min.										
	101:15min.										

				0 17 114 1				
				Specified Value		1	1	Test Methods and Remarks
Item	LEM2520	LB2518 LB2016 LB2012 LB1608	LBC2518 LBC2016 LBC2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	LBH1608	
20.Loading under	△L/L→	△L/L→Within±10	0%				△L/L→	LEM·LB·LBC·CB·CBC·CBL:
damp heat	Within±10%						Within±5%	Temperature: 60±2°C (Excluding nH range)
	Q→						%△L/L→	Humidity: 90~95%RH
	R12~4R7:						within±0.5nH	Duration: 1000 hrs
	30min.						under 8.2 n H	Applied current : Rated current
	5R6~330:						△Q/Q→	Recovery: At least 1 hr of recovery the stan-
	25min.						within±20%	dard condition after the removal
	390~820:						%△Q/Q→	from test chamber, followed by
	20min.						within±5 under	measurement within 2 hrs.
	101:15min.						8.2 n H	
				1				
21.High temperaturte	△L/L→ Within±10%		/	△L/L→Within±10	J%		/	LEM · CB · CBC · CBL :
life test	Within±10% Q→		/				/	Temperature : 85±2℃
	10N: 10min.						/	Duration: 1000 hrs
	12N~33N:						/	Recovery: At least 1 hr of recovery the stan- dard condition after the removal
	15min.						/	from test chamber, followed by
	39N~R10:						/	measurement within 2 hrs.
	20min.		/				/	measurement within 2 ms.
	R12~4R7:	/	/				/	
	30min.	/					/	
	5R6~330 :	/					/	
	25min.	/					/	
	390~820:	/					/	
	20min.	/					/	
	101:15min.	/					/	
							/	
22.Loading at high		△L/L→Within±1	0%				△L/L→	LB·LBC:
temperature							Within±5%	Temperature: 85±2°C (Excluding nH range)
							%△L/L→	Duration: 1000 hrs
							within±0.5nH	Applied current : Rated current
						•	under	Recovery: At least 1 hr of recovery the stan-
							8.2 n H	dard condition after the removal
							△Q/Q→	from test chamber, followed by
				,			Within±20%	measurement within 2 hrs.
				/			%△Q/Q→	
							within±0.5	
							under 8.2 n H	
		1		V				

Item				Specified Value				
	LEM2520	LB2518 LB2016 LB2012 LB1608	LBC2518 LBC2016 LBC2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	LBH1608	Test Methods and Remarks
23.Low temperature \triangle	ZL/L→	△L/L→Within±109	6			1	△L/L→	LEM · LB · LBC · CB · CBC · CBL · LBH
life test W	Vithin±10%						Within±5%	Temperature: -40±2℃
Q.)→						%△L/L→	Duration: 1000 hrs
10	0N:10min.						within±0.5nH	Recovery: At least 1 hr of recovery the stan-
12	2N~33N:						under 8.2 n H	dard condition after the removal
15	5min.						△Q/Q→	from test chamber, followed by
39	9N~R10:						Within±20%	measurement within 2 hrs.
20	Omin.						%△Q/Q→	
R.	R12~4R7:						within±5 under	
30	Omin.						8.2 n H	
5F	R6~330:							
25	5min.							
	90~820:							
	0min.							
10	01:15min.							
24.Standard condition "S	Sutandard con-	Standard test cond	dition: Unless ohe	rwise specified,Te	mperature20±15°C	of temperature, 6	5±20% of relative	
		humidity.When the						
		be condition of 20±				•	•	
		Inductance is in a			. ,			
	ollows: 5 to 35							
	C of tempera-							
	ure, 45 to 85%							
	elative humid-							
	y, and 86 to							
-	06kPa of air							
	ressure.When							
	nere are ques-							
	ons concerning							
	neasurement							
	esults : In or-							
	er to provide							
	orrelation data,							
	ne test shall be							
	onducted un-							
	er condition of							
	0±2°C of tem-							
	erature, 45 to							
1.	5% to 106kPa							
	f air pressure.							
	Inless other-							
	ise specified							
	Il the test are							
	onducted un-							
	er the "stan-							
da	ard condition"							

PRECAUTIONS

LEM Type, LB Type, CB Type

Stages	Precautions	Technical considerations
1.Circuit Design	Operating environment, 1.The products described in this specification are intended for	
	use in general electronic equipment,(office supply	
	equipment, telecommunications systems, measuring	
	equipment, and household equipment). They are not	
	intended for use in mission-critical equipment or systems	
	requiring special quality and high reliability (traffic systems,	
	safety equipment, aerospace systems, nuclear control	
	systems and medical equipment including life-support	
	systems,) where product failure might result in loss of life,	
	injury or damage. For such uses, contact TAIYO YUDEN	
2.PCB Design	Sales Department in advance. Land pattern design	
z.i Ob booigii	1.Please contact any of our offices for a land pattern, and refer	
	to a recommended land pattern of specifications.	
3.Considerations for	Adjustment of mounting machine	
automatic placement	1.Excessive impact load should not be imposed on the	Nhen installing products, care should be taken not to apply distortion stress as it may
	products when mounting onto the PC boards.	deform the products.
	2.Mounting and soldering conditions should be checked	
	beforehand.	
4.Soldering	Wave soldering	
	1.Please refer to the specifications in the catalog for a wave	
	soldering.	
	Reflow soldering	
	1.Please contact any of our offices for a reflow soldering, and	1.lf products are used beyond the range of the recommended conditions, heat stress
	refer to the recommended condition specified.	may deform the products, and consequently degrade the reliability of the products.
	2.LB Type, CB Type	
	Reflow solderring only.	
	Lead free soldering	
	1.When using products with lead free soldering, we request to use them after confirming of adhesion, temperature of	
	resistance to soldering heat, etc. sufficiently.	
	Recommended conditions for using a soldering iron	
	Put the soldering iron on the land-pattern.	
	Soldering iron's temperature - Below 350 °C	
	Duration - 3 seconds or less	
	The soldering iron should not directly touch the inductor.	
5.Cleaning	Cleaning conditions	
	LB Type, CB Type	LB Type, CB Type
	Number of the supersonic waves shall be avoided.	1.lf washing by supersonic waves, supersonic waves may cause broken products.
6.Handling	Handling	
	1.Keep the inductors away from all magnets and magnetic	1.There is a case that a characteristic varies with magnetic influence.
	objects.	
	Breakaway PC boards (splitting along perforations)	
	1. When splitting the PC board after mounting inductors, care	1.Planning pattern configurations and the position of products should be carefu
	should be taken not to give any stresses of deflection or	performed to minimize stress.
	twisting to the board. 2.Board separation should not be done manually, but by using	
	the appropriate devices.	
	Mechanical considerations	
	1.Please do not give the inductors any excessive mechanical	1.There is a case to be damaged by a mechanical shock.
	shocks.	
7.Storage conditions	Storage	
	1.To maintain the solderability of terminal electrodes and to	Under a high temperature and humidity environment, problems such as reduce
	keep the packing material in good condition, temperature	solderability caused by oxidation of terminal electrodes and deteriorati
	and humidity in the storage area should be controlled.	of taping/packaging materials may take place.
	Recommended conditions	
	Ambient temperature 0~40°C	
	Humidity Below 70% RH	
	The ambient temperature must be kept below 30°C Even under	
	ideal storage conditions, solderability of products electrodes may	
	decrease as time passes. For this reason, LE type inductors	
	should be used within one year from the time of delivery.	
	LB type	
	Please should be used within 6 months from the time of delivery.	
	LE type	
		I .
	In case of storage over 6 months, solderability shall be checked before actual usage.	